

N-Channel 200 V (D-S) MOSFET

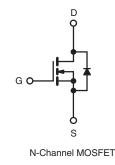
PRODUCT SUMMARY						
V _{DS} (V)	200					
R _{DS(on)} (Ω)	V _{GS} = 10 V	0.265				
Q _g (Max.) (nC)	16					
Q _{gs} (nC)	5					
Q _{gd} (nC)	8					
Configuration	Single					

FEATURES

- · Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Distance = 4.8 mm
- 175 °C Operating Temperature
- · Dynamic dV/dt Rating
- Low Thermal Resistance
- Lead (Pb)-free Available







ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, unl	ess otherw	ise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	200	v	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	- I _D -	10		
	VGS AL TO V	T _C = 100 °C		6.5	A	
Pulsed Drain Current ^a			I _{DM}	32		
Linear Derating Factor				0.24	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	36	mJ	
Repetitive Avalanche Current ^a			I _{AR}	7.2	A	
Repetitive Avalanche Energy ^a			E _{AR}	3.7	mJ	
Maximum Power Dissipation	T _C = 25 °C		PD	37	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting rorque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 1.0 mH, $R_G = 25 \Omega$, $I_{AS} = 7.2 \text{ A}$ (see fig. 12). c. $I_{SD} \le 9.2 \text{ A}$, dl/dt $\le 110 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$.

d. 1.6 mm from case.



THERMAL RESISTANCE RA	TINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 65							
Maximum Junction-to-Case (Drain)	R _{thJC}	- 4.1				°C/W			
SPECIFICATIONS $T_J = 25 \ ^{\circ}C$,	unless otherw	vise noted			-	-			
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = 2	50 μΑ	200	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.13	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D = 2$	250 μΑ	2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	l v	$I_{\rm GS} = \pm 20$	V	-	-	± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} =	$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	25	μΑ	
	IDSS	V _{DS} =160 V, V _{GS} = 0 V, T _J = 150 °C			-	-	250		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 4.3 A ^b	-	0.265	-	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 4.3 \text{ A}^{b}$		2.3	-	-	S		
Dynamic									
Input Capacitance	C _{iss}			-	560	-			
Output Capacitance	C _{oss}	,	V _{GS} = 0 V, V _{DS} = 25 V,		-	260	-	1 _	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5 f = 1.0 MHz		-	110	-	pF		
Drain to Sink Capacitance	С			-	12	-			
Total Gate Charge	Qg				-	-	16		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A},$		-	-	4.4	nC	
Gate-Drain Charge	Q _{gd}		366 H	g. 6 and 13 ^b	-	-	7.7		
Turn-On Delay Time	t _{d(on)}	•			-	8.8	-		
Rise Time	t _r	$\begin{array}{l} {\sf V}_{{\sf D}{\sf D}}\ =\ 100\ {\sf V},\ {\sf I}_{{\sf D}}\ =\ 9.2\ {\sf A},\\ {\sf R}_{{\sf G}}\ =\ 18\ \Omega,\ {\sf R}_{{\sf D}}\ =\ 5.2\ \Omega,\\ {\sf see\ fig.\ 10^b} \end{array}$		-	30	-	ns		
Turn-Off Delay Time	t _{d(off)}			-	19	-			
Fall Time	t _f			-	20	-			
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	L _S			-	7.5	-			
Drain-Source Body Diode Characteristic	cs								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	10	-	A		
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode			-	32		-	
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$T_{J} = 25 \text{ °C}, I_{S} = 7.2 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = 9.2 \text{ A}, dI/dt = 100 \text{ A}/\mu s^{b}$		-	130	260	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.65	1.3	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)							

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.





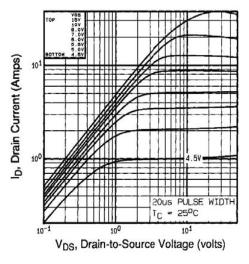


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

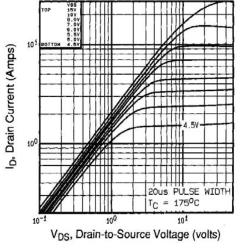


Fig. 2 - Typical Output Characteristics, T_C = 175 $^\circ C$

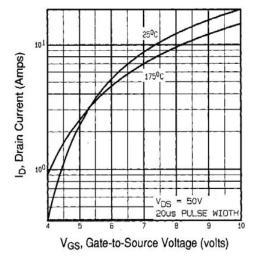


Fig. 3 - Typical Transfer Characteristics

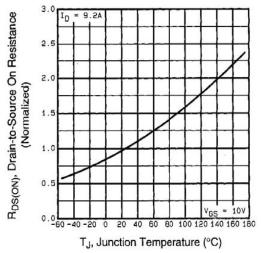


Fig. 4 - Normalized On-Resistance vs. Temperature

IRFI610GPBF



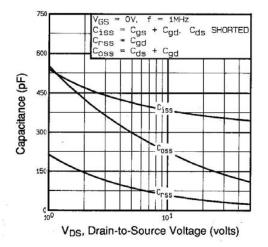


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

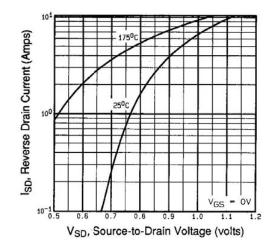


Fig. 7 - Typical Source-Drain Diode Forward Voltage

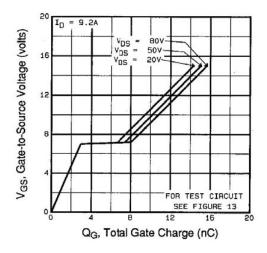


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

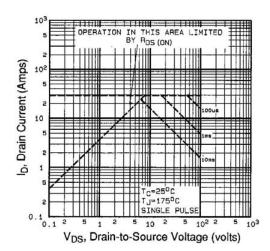


Fig. 5 - Fig. 8 - Maximum Safe Operating Area

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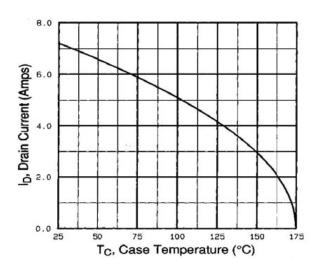


Fig. 9 - Maximum Drain Current vs. Case Temperature

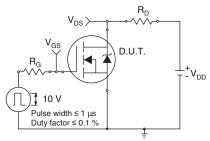


Fig. 10a - Switching Time Test Circuit

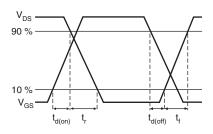
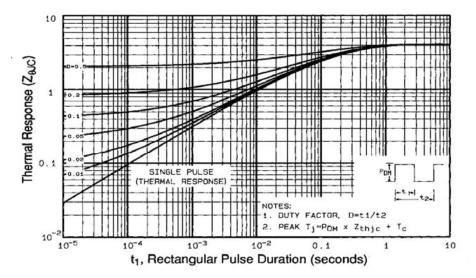
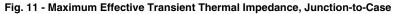


Fig. 10b - Switching Time Waveforms





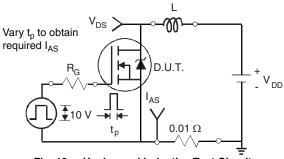


Fig. 12a - Unclamped Inductive Test Circuit

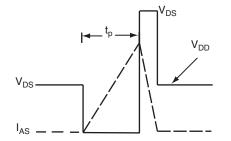
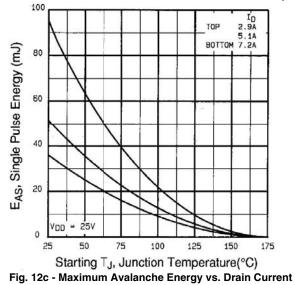


Fig. 12b - Unclamped Inductive Waveforms







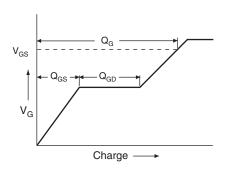
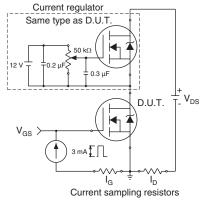
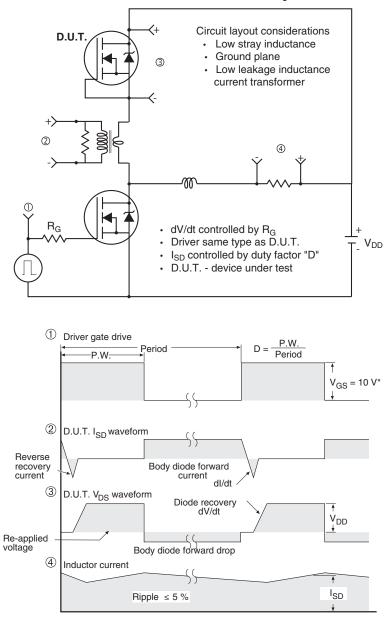


Fig. 13a - Basic Gate Charge Waveform









Peak Diode Recovery dV/dt Test Circuit

* V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel



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